TOSHIBA Field Effect Transistor Silicon P Channel MOS Type (π–MOSV)

2SJ516

Chopper Regulator, DC-DC Converter and Motor Drive Applications

• Low drain-source ON resistance : $R_{DS (ON)} = 0.6 \Omega (typ.)$

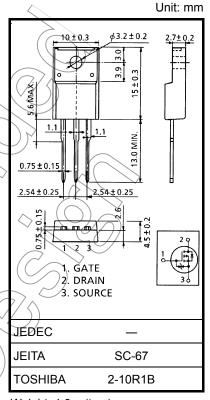
• High forward transfer admittance : |Y_{fs}| = 5.3 S (typ.)

• Low leakage current : $I_{DSS} = -100 \mu A \text{ (max) (V}_{DS} = -250 \text{ V)}$

• Enhancement mode : $V_{th} = -1.5$ to -3.5 V ($V_{DS} = -10$ V, $I_D = -1$ mA)

Absolute Maximum Ratings (Ta = 25°C)

Characteris	etics	Symbol	Rating	Unit
Drain-source voltage		V_{DSS}	-250	A
Drain-gate voltage (Ro	_{SS} = 20 kΩ)	V_{DGR}	-250	V
Gate-source voltage		V_{GSS}	±20	> v
Drain current	DC (Note 1)	ΙD	-6.5	Α
Diam current	Pulse (Note 1)	I _{DP}	-13	A
Drain power dissipation	n (Tc = 25°C)	PD	35	/_w
Single pulse avalanche	e energy (Note 2)	E _A \$	157	Æ
Avalanche current		TAR	-6.5	A
Repetitive avalenche e	nergy (Note 3)	((EAR))	3.5	Lm/
Channel temperature		Tch	150	°C
Storage temperature ra	nge	T _{stg}	-55 to 150	°C



Weight: 1.9 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Thermal Characteristics

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to case	Rth (ch-c)	3.57	°C/W
Thermal resistance, channel to ambient	R _{th (ch-a)}	62.5	°C / W

Note 1: Please use devices on condition that the channel temperature is below 150°C.

Note 2: V_{DD} = -50 V, T_{ch} = 25°C (initial), L = 6.3 mH, R_G = 25 Ω , I_{AR} = -6.5 A

Note 3: Repetitive rating; Pulse width limited by maximum channel temperature.

This transistor is an electrostatic sensitive device.

Please handle with caution.

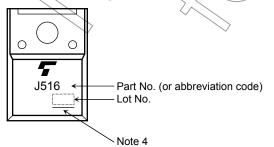
Electrical Characteristics (Ta = 25°C)

Charac	cteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cu	ırrent	I _{GSS}	V _{GS} = ±16 V, V _{DS} = 0 V	_	_	±10	μΑ
Drain cut-off cu	rrent	I _{DSS}	V _{DS} = -250 V, V _{GS} = 0 V	_	_	-100	μA
Drain-source breakdown volta	age	V _(BR) DSS	$I_D = -10 \text{ mA}, V_{GS} = 0 \text{ V}$	-250	_		٧
Gate threshold	voltage	V _{th}	V _{DS} = -10 V, I _D = -1 mA	(1.5	7	-3.5	V
Drain-source O	N resistance	R _{DS} (ON)	V _{GS} = -10 V, I _D = -3 A		0.6	0.8	Ω
Forward transfe	r admittance	Y _{fs}	V _{DS} = -10 V, I _D = -3 A	2.5	5.3	_	S
Input capacitance		C _{iss}		2	1120	_	
Reverse transfer capacitance		C _{rss}	V _{DS} = -10 V, V _{GS} = 0 V, f = 1 MHz	· —	110	-	pF
Output capacitance		Coss		_	320		
Switching time	Rise time	t _r	$V_{GS} \stackrel{OV}{\longrightarrow} I_{D} = 3A$ $V_{OUT} \stackrel{VOUT}{\longrightarrow} R_{L} = 33.3 \Omega$	-	17	/	- ns
	Turn-on time	t _{on}			34) —	
	Fall time	t _f	$V_{DD} = -100V$		> 6	ı	
	Turn-off time	t _{off}	Duty $\leq 1\%$, $t_{\rm W} = 10 \mu {\rm s}$)	71		
Total gate charge (Gate-source plus gate-drain)		Qg		_	29	_	
Gate-source charge		Q _{gs}	$V_{DD} \approx -200 \text{ V, V}_{GS} = -10 \text{ V, I}_{D} = -6.5 \text{ A}$	_	19	_	nC
Gate-drain ("miller") charge		Q _{gd}		_	10	_	

Source-Drain Ratings and Characteristics (Ta=

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	Jór	<u> </u>	ı	ı	-6.5	Α
Pulse drain reverse current (Note 1)) I _{DRP}	_	_	_	-13	Α
Forward voltage (diode)	V_{DSF}	I _{DR} = -6.5 A, V _{GS} = 0 V	_	_	2.0	V
Reverse recovery time	t _{rr}	I _{DR} = -6.5 A, V _{GS} = 0 V		190	_	ns
Reverse recovery charge	Qrr	dl _{DR} / dt = 100 A / μs	_	2.1	_	μC

Marking

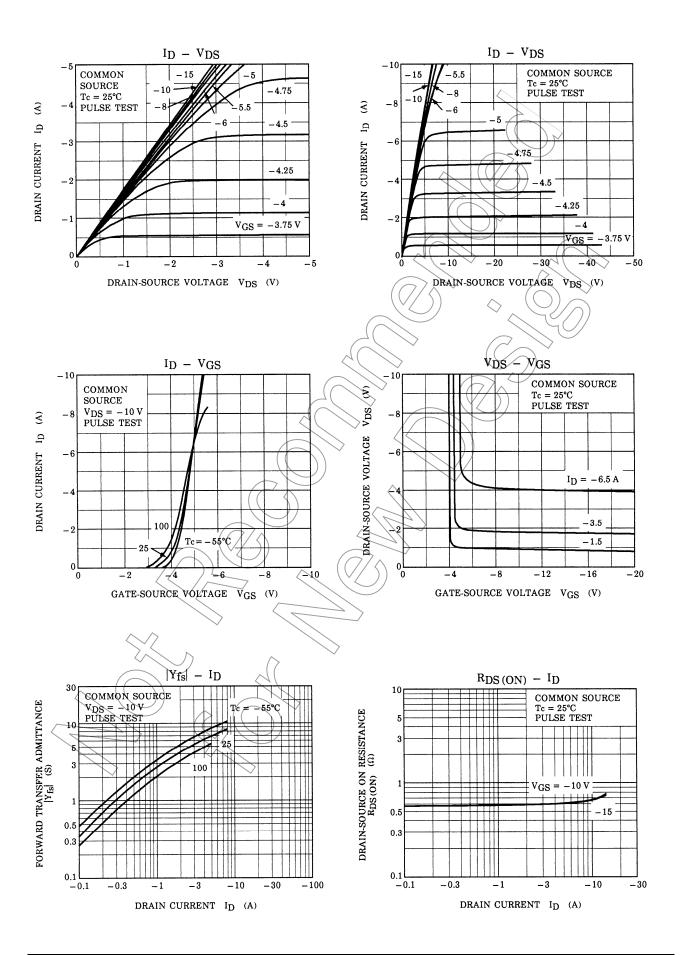


Note 4: A line under a Lot No. identifies the indication of product Labels.

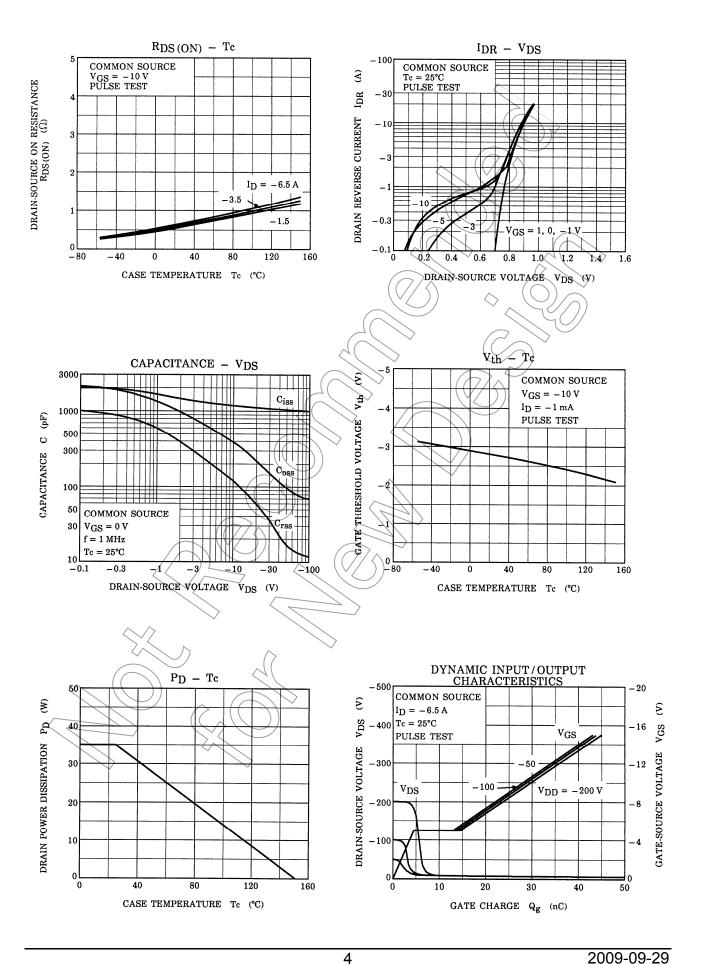
Not underlined: [[Pb]]/INCLUDES > MCV

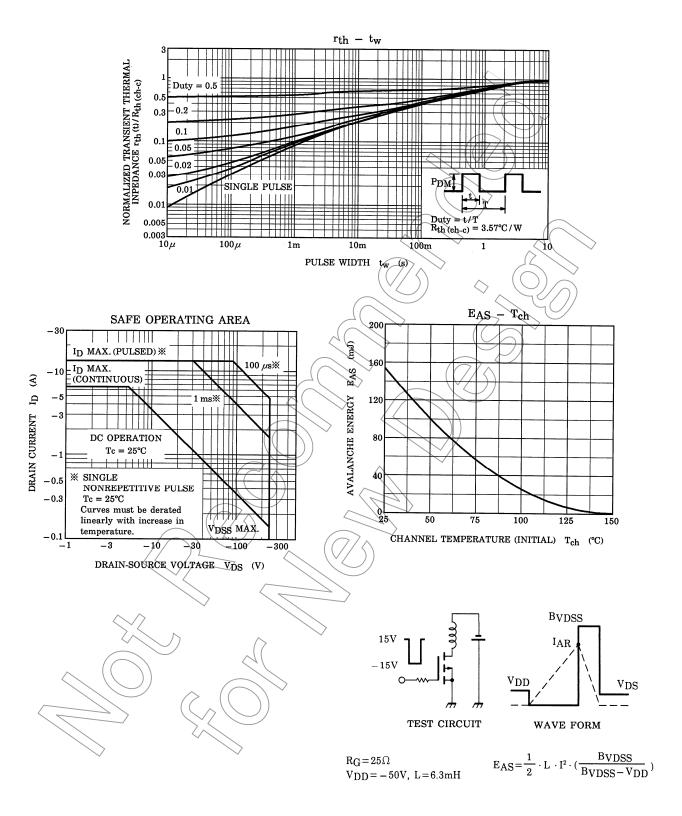
Underlined: [[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]

Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product. The RoHS is the Directive 2002/95/EC of the European Parliament and of the Council of 27 January 2003 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.



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